

SIM Lab Report

Work Order - Placeholder Number

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1 Work Order Details

Work Order No	Placeholder Number
Work Order Raised By	Placeholder Name
Work Order Raised On	02 Jul 24
Sample Received Date	02 Jul 24
SIM Card Manufacturer	Placeholder Manufacturer
Testing Period	10th Sep 2020 - 15th Sep 2020
Testing Method	Stress Testing
Test Result(s)	Please refer to next pages(s)

1.1 Test Requested

In this work order Airtel SIM Lab is intending to perform the complete Offline and Online testing on above mentioned BATCH Cards received from xxx circle.

1.2 Test Cases Selected

Following test cases were selected based on work order type

- Placeholder Test Case 1
- Placeholder Test Case 2

2 Testing

Placeholder for Testing Section

2.1 Vital Testing

Placeholder for Vital Testing Section

2.2 Physical Testing

Placeholder for Physical Testing Section

2.2.1 Test Procedure

Placeholder for Test Procedure Section

2.2.2 Card Thickness Testing

Placeholder for Card Thickness Testing Section

2.2.3 Go-No-Go (3FF & 4FF) Testing

Placeholder for Go-No-Go (3FF & 4FF) Testing Section

2.3 Constant Voltage Stress Testing

Placeholder for Constant Voltage Stress Testing Section

2.3.1 Applications & Necessary DF on the Card

Placeholder for Applications & Necessary DF on the Card Section

2.3.2 Test Procedure

Placeholder for Test Procedure Section

2.3.3 Action Performed on SIM

Placeholder for Action Performed on SIM Section

2.3.4 Card State After Action Performed

Placeholder for Card State After Action Performed Section

2.4 Voltage Testing on Class A B and C

Placeholder for Voltage Testing on Class A B and C Section

2.4.1 Test Procedure

Placeholder for Test Procedure Section

2.4.2 Testing Details

Placeholder for Testing Details Section

2.5 Profile Conformance against latest STANDARD Profile

Placeholder for Profile Conformance against latest STANDARD Profile Section

2.5.1 Test Procedure

Placeholder for Test Procedure Section

2.6 Network Latching Sequence

Placeholder for Network Latching Sequence Section

2.7 DSA Testing

Placeholder for DSA Testing Section

2.7.1 Testing Details

Placeholder for Testing Details Section

2.8 Online Testing in Real Case Scenario

Placeholder for Online Testing in Real Case Scenario Section

2.8.1 Testing Details

Placeholder for Testing Details Section

2.9 DSTK Testing

Placeholder for DSTK Testing Section

2.9.1 Test Procedure

Placeholder for Test Procedure Section

2.9.2 Applications & Necessary DF on the Card

Placeholder for Applications & Necessary DF on the Card Section

2.9.3 Action Performed on SIM

Placeholder for Action Performed on SIM Section

2.9.4 Card State After Action Performed

Placeholder for Card State After Action Performed Section